

■ PRODUCT CHARACTERISTICS

V_{DS}	60V
$R_{DS(on)typ}(@V_{GS}=10V)$	26m Ω
$R_{DS(on)typ}(@V_{GS}=4.5V)$	30m Ω
I_D	9.2A

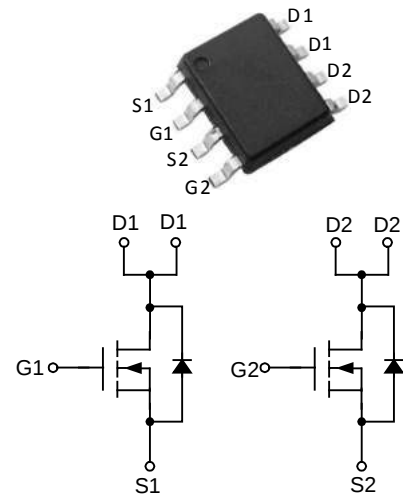
■ FEATURE

- Low $R_{DS(ON)}$
- Low gate charge
- Pb-free lead plating

■ APPLICATIONS

- Motor driving in power tool
- E-vehicle robotics

Pin description



■ ORDER INFORMATION

Order codes		Package	Packing
Halogen-free	Halogen		
N/A	MOT6929S	SOP-8L	4000Pieces/Reel

■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Value	Units
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	9.2	A
		5.3	A
Pulsed Drain Current	I_{DM}	37	A
Avalanche Energy	E_{AS}	70	mJ
Maximum Power Dissipation	P_D	1.4	W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	89	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 150	$^\circ\text{C}$

■ Electrical Characteristics (T_C=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	I _D = 250μA, V _{GS} = 0V	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V	-	-	1.0	μA
Gate-Body Leakage Current	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
On characteristics						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1	1.58	2.5	V
Static Drain-Source ON-Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 9A	-	26	29	mΩ
		V _{GS} = 4.5V, I _D = 5A	-	30	38	mΩ
Dynamic characteristics						
Gate Resistance	R _g	f = 1MHz	-	1.4	-	Ω
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 20V, f = 1MHz	-	1378	-	pF
Output Capacitance	C _{oss}		-	73	-	pF
Reverse Transfer Capacitance	C _{rss}		-	64	-	pF
Total Gate Charge	Q _g	V _{GS} = 0 to 10V V _{DS} = 30V, I _D = 9A	-	50	-	nC
Gate Source Charge	Q _{gs}		-	9	-	nC
Gate Drain("Miller") Charge	Q _{gd}		-	8	-	nC
Switching characteristics						
Turn-On DelayTime	t _{d(on)}	V _{GS} = 10V, V _{DD} = 30V I _D = 9A , R _{GEN} = 3Ω	-	9	-	nS
Turn-On Rise Time	t _r		-	15	-	nS
Turn-Off DelayTime	t _{d(off)}		-	44	-	nS
Turn-Off Fall Time	t _f		-	7	-	nS
Body diode characteristics						
Maximum Continuous Forward Current	I _S		-	-	9	A
Maximum Pulsed Forward Current	I _{SM}		-	-	37	A
Body Diode Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 9A	-	-	1.2	A
Body Diode Reverse Recovery Time	t _{rr}	I _F = 9A, di/dt = 100A/us	-	21	-	nS
Body Diode Reverse Recovery Charge	Q _{rr}		-	21	-	nS

■ TYPICAL CHARACTERISTICS

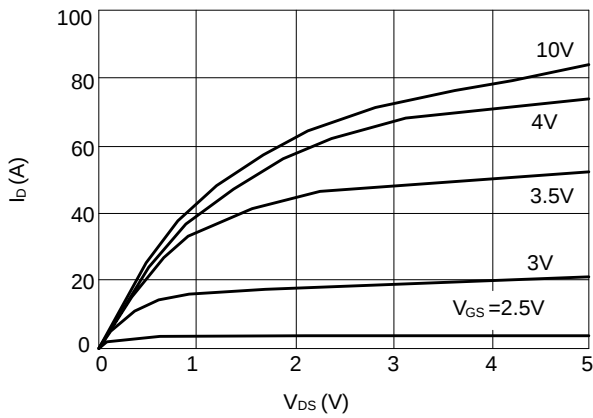


Figure 1: Output characteristics

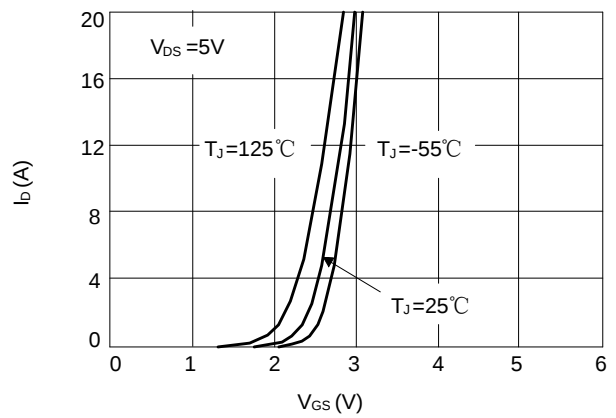


Figure 2: Typical transfer characteristics

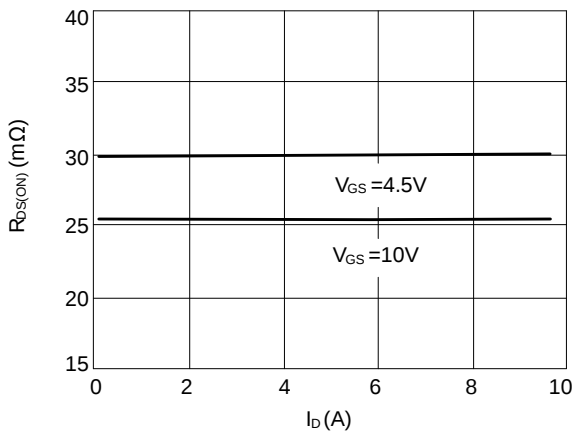


Figure 3: On-resistance vs. drain current

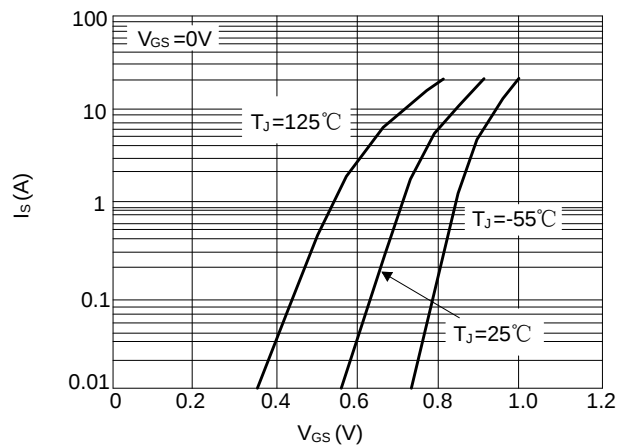


Figure 4: Body diode characteristics

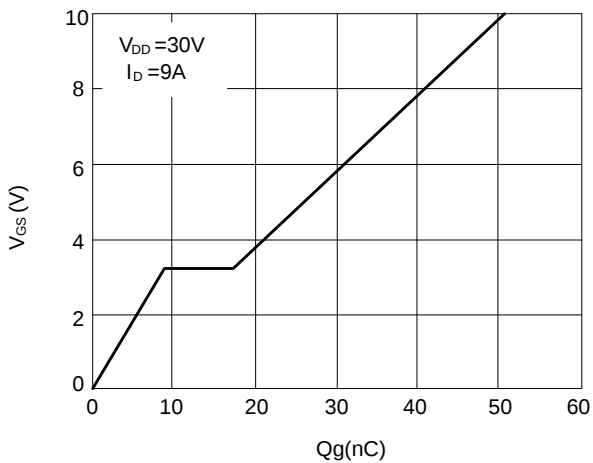


Figure 5: Gate charge characteristics

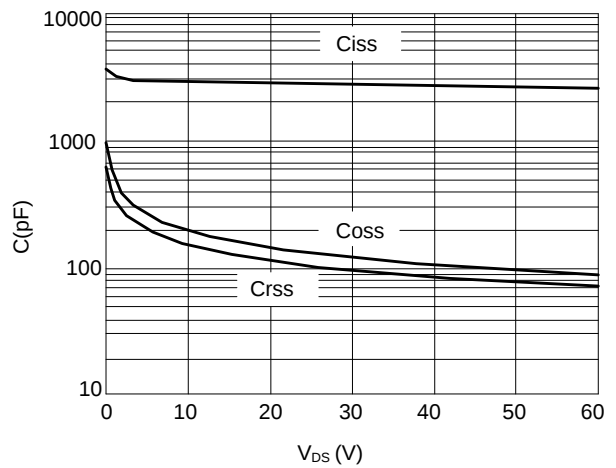


Figure 6: Capacitance characteristics

■ TYPICAL CHARACTERISTICS(Cont.)

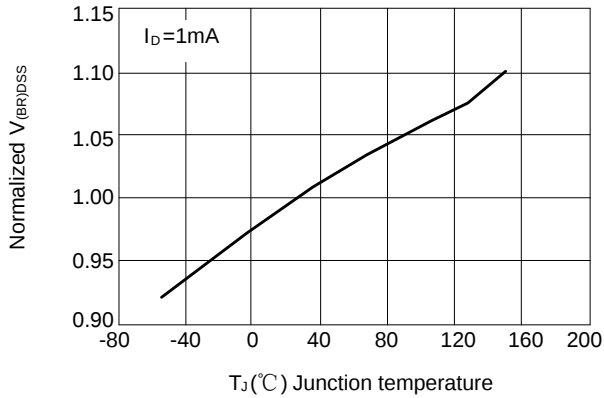


Figure 7: Normalized breakdown voltage vs. junction temperature

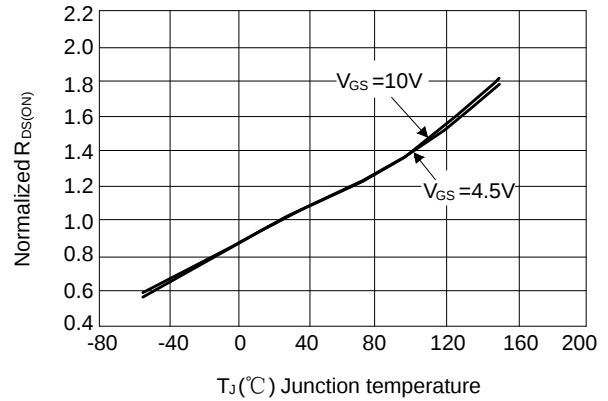


Figure 8: Normalized on resistance vs. junction temperature

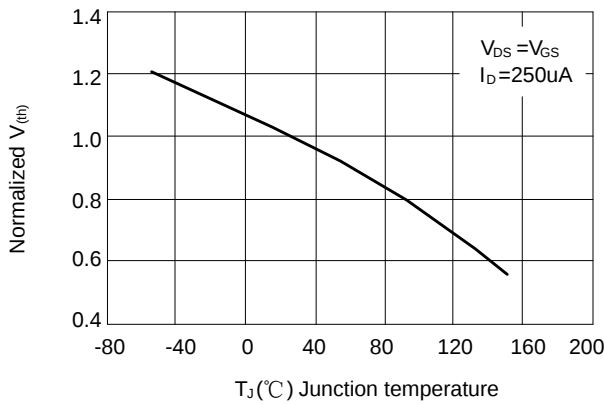


Figure 9: Normalized threshold voltage vs. junction temperature

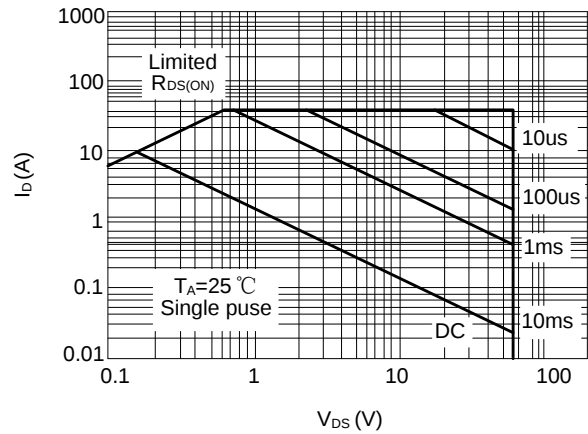


Figure 10: Maximum safe operating area